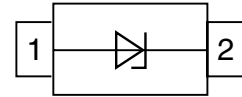
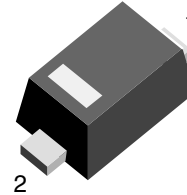


Small Signal Zener Diodes

Features

- With the BZX584C..-02V series vishay offers a Z-Diode in the tiny SOD523 plastic package. Made for space sensitive applications the BZX584C..-02V series has a zener voltage tolerance of $\pm 5\%$.
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



18426

Mechanical Data

Case: SOD523 Plastic case

Weight: approx. 1.6 mg

Packaging Codes/Options:

GS08/3 k per 7" reel (8 mm tape), 15 k/box

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Power dissipation		P_{tot}	200 ¹⁾	mW

Note:

¹⁾ Device on fiberglass substrate

Thermal Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air		R_{thJA}	680 ¹⁾	K/W
Thermal resistance junction to soldering point		R_{thJS}	100	K/W
Junction temperature		T_j	150	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 65 to + 150	$^{\circ}\text{C}$

Note:

¹⁾ Device on fiberglass substrate

BZX584C-02V Series



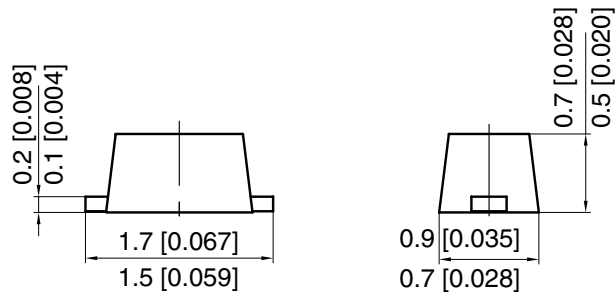
Vishay Semiconductors

Electrical Characteristics

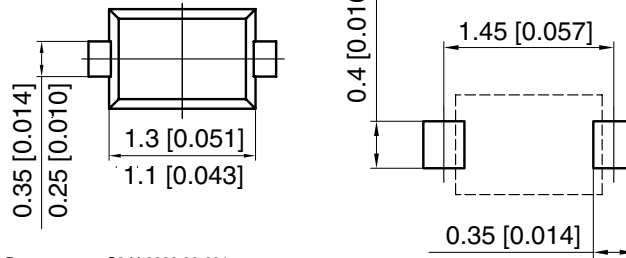
Partnumber	Marking Code	Zener Voltage Range		Dynamic Resistance		Test Current	Temp. Coefficient of Zener Voltage		Test Current	Reverse Leakage Current			
		V_Z at 5 mA		r_{zj} at I_{ZT1}	r_{zj} at I_{ZT2}		I_{ZT1}	α_{VZ} at 5 mA		I_{ZT2}	I_R	at V_R	
		V		Ω			mA	$10^{-4}/^{\circ}\text{C}$		mA	μA	V	
		min	max					min		max			
BZX584C2V4-02V	2	2.2	2.6	70 (≤ 100)	275 (≤ 600)	5	-9.0	-4.0	1	50	1		
BZX584C2V7-02V	3	2.5	2.9	75 (≤ 100)	300 (≤ 600)	5	-9.0	-4.0	1	20	1		
BZX584C3V0-02V	4	2.8	3.2	80 (≤ 95)	325 (≤ 600)	5	-9.0	-3.0	1	10	1		
BZX584C3V3-02V	5	3.1	3.5	85 (≤ 95)	350 (≤ 600)	5	-8.0	-3.0	1	5	1		
BZX584C3V6-02V	6	3.4	3.8	85 (≤ 90)	375 (≤ 600)	5	-8.0	-3.0	1	5	1		
BZX584C3V9-02V	7	3.7	4.1	85 (≤ 90)	400 (≤ 600)	5	-7.0	-3.0	1	3	1		
BZX584C4V3-02V	8	4	4.6	80 (≤ 90)	410 (≤ 600)	5	-6.0	-1.0	1	3	1		
BZX584C4V7-02V	9	4.4	5	50 (≤ 80)	425 (≤ 500)	5	-5.0	+2.0	1	3	2		
BZX584C5V1-02V	1	4.8	5.4	40 (≤ 60)	400 (≤ 480)	5	-3.0	+4.0	1	2	2		
BZX584C5V6-02V	0	5.2	6	15 (≤ 40)	80 (≤ 400)	5	-2.0	+6.0	1	1	2		
BZX584C6V2-02V	1	5.8	6.6	6.0 (≤ 10)	40 (≤ 150)	5	-1.0	+7.0	1	3	4		
BZX584C6V8-02V	2	6.4	7.2	6.0 (≤ 15)	30 (≤ 80)	5	+2.0	+7.0	1	2	4		
BZX584C7V5-02V	3	7	7.9	6.0 (≤ 15)	30 (≤ 80)	5	+3.0	+7.0	1	1	5		
BZX584C8V2-02V	4	7.7	8.7	6.0 (≤ 15)	40 (≤ 80)	5	+4.0	+7.0	1	0.7	5		
BZX584C9V1-02V	5	8.5	9.6	6.0 (≤ 15)	40 (≤ 100)	5	+5.0	+8.0	1	0.5	6		
BZX584C10-02V	6	9.4	10.6	8.0 (≤ 20)	50 (≤ 150)	5	+5.0	+8.0	1	0.2	7		
BZX584C11-02V	7	10.4	11.6	10 (≤ 20)	50 (≤ 150)	5	+5.0	+9.0	1	0.1	8		
BZX584C12-02V	8	11.4	12.7	10 (≤ 25)	50 (≤ 150)	5	+6.0	+9.0	1	0.1	8		
BZX584C13-02V	9	12.4	14.1	10 (≤ 30)	50 (≤ 170)	5	+7.0	+9.0	1	0.1	8		
BZX584C15-02V	0	13.8	15.6	10 (≤ 30)	50 (≤ 200)	5	+7.0	+9.0	1	0.1	8		
BZX584C16-02V	1	15.3	17.1	10 (≤ 40)	50 (≤ 200)	5	+8.0	+9.5	1	0.05	$0.7 V_{Znom}$		
BZX584C18-02V	2	16.8	19.1	10 (≤ 45)	50 (≤ 225)	5	+8.0	+9.5	1	0.05	$0.7 V_{Znom}$		
BZX584C20-02V	3	18.8	21.2	15 (≤ 55)	60 (≤ 225)	5	+8.0	+10	1	0.05	$0.7 V_{Znom}$		
BZX584C22-02V	4	20.8	23.3	20 (≤ 55)	60 (≤ 250)	5	+8.0	+10	1	0.05	$0.7 V_{Znom}$		
BZX584C24-02V	5	22.8	25.6	25 (≤ 70)	60 (≤ 250)	5	+8.0	+10	1	0.05	$0.7 V_{Znom}$		
BZX584C27-02V	6	25.1	28.9	25 (≤ 80)	65 (≤ 300)	2	+8.0	+10	0.5	0.05	$0.7 V_{Znom}$		
BZX584C30-02V	K	28	32	30 (≤ 80)	70 (≤ 300)	2	+8.0	+10	0.5	0.05	$0.7 V_{Znom}$		
BZX584C33-02V	e	31	35	35 (≤ 80)	75 (≤ 325)	2	+8.0	+10	0.5	0.05	$0.7 V_{Znom}$		
BZX584C36-02V	q	34	38	35 (≤ 90)	80 (≤ 350)	2	+8.0	+10	0.5	0.05	$0.7 V_{Znom}$		
BZX584C39-02V	fl	37	41	40 (≤ 130)	80 (≤ 350)	2	+10	+12	0.5	0.05	$0.7 V_{Znom}$		
BZX584C43-02V	l	40	46	45 (≤ 150)	85 (≤ 375)	2	+10	+12	0.5	0.05	$0.7 V_{Znom}$		
BZX584C47-02V	L	44	50	50 (≤ 170)	85 (≤ 375)	2	+10	+12	0.5	0.05	$0.7 V_{Znom}$		
BZX584C51-02V	M	48	54	60 (≤ 180)	85 (≤ 400)	2	+10	+12	0.5	0.05	$0.7 V_{Znom}$		



Package Dimensions in millimeters (inches): SOD523



foot print recommendation:



Document no.: S8-V-3880.02-001
Rev. f - Date: 25. January. 2005
16864

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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